

# SN75161B, SN75162B OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

SLLS005B – OCTOBER 1980 – REVISED MAY 1995

- Meets IEEE Standard 488-1978 (GPIB)
- 8-Channel Bidirectional Transceivers
- Power-Up/Power-Down Protection (Glitch Free)
- Designed to Implement Control Bus Interface
- SN75161B Designed for Single Controller
- SN75162B Designed for Multiple Controllers
- High-Speed, Low-Power Schottky Circuitry
- Low Power Dissipation . . . 72 mW Max Per Channel
- Fast Propagation Times . . . 22 ns Max
- High-Impedance pnp Inputs
- Receiver Hysteresis . . . 650 mV Typ
- Bus-Terminating Resistors Provided on Driver Outputs
- No Loading of Bus When Device Is Powered Down ( $V_{CC} = 0$ )

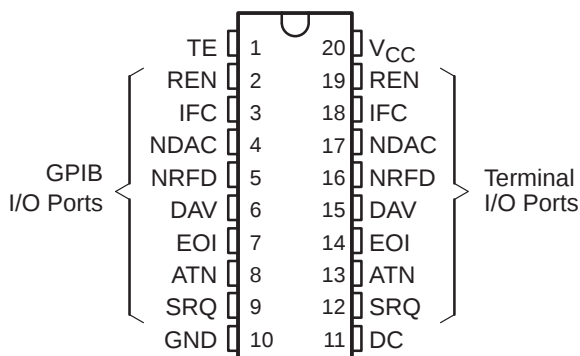
## description

The SN75161B and SN75162B eight-channel, general-purpose interface bus transceivers are monolithic, high-speed, low-power Schottky devices designed to meet the requirements of IEEE Standard 488-1978. Each transceiver is designed to provide the bus-management and data-transfer signals between operating units of a single- or multiple-controller instrumentation system. When combined with the SN75160B octal bus transceiver, the SN75161B or SN75162B provides the complete 16-wire interface for the IEEE-488 bus.

The SN75161B and SN75162B feature eight driver-receiver pairs connected in a front-to-back configuration to form input/output (I/O) ports at both the bus and terminal sides. A power-up/-down disable circuit is included on all bus and receiver outputs. This provides glitch-free operation during  $V_{CC}$  power up and power down.

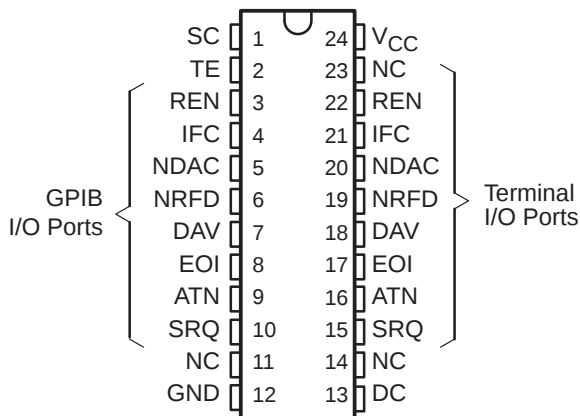
SN75161B . . . DW OR N PACKAGE

(TOP VIEW)



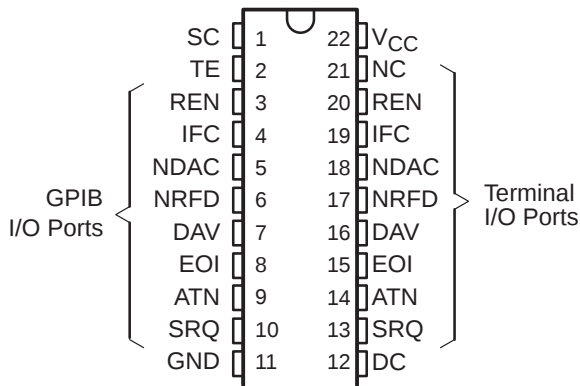
SN75162B . . . DW PACKAGE

(TOP VIEW)



SN75162B . . . N PACKAGE

(TOP VIEW)



NC—No internal connection



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**TEXAS  
INSTRUMENTS**

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# SN75161B, SN75162B

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### description (continued)

The direction of data through these driver-receiver pairs is determined by the DC, TE, and SC (on SN75162B) enable signals. The SC input on the SN75162B allows the REN and IFC transceivers to be controlled independently.

The driver outputs (GPIB I/O ports) feature active bus-terminating resistor circuits designed to provide a high impedance to the bus when supply voltage  $V_{CC}$  is 0. The drivers are designed to handle loads up to 48 mA of sink current. Each receiver features pnp transistor inputs for high input impedance and hysteresis of 400 mV for increased noise immunity. All receivers have 3-state outputs to present a high impedance to the terminal when disabled.

The SN75161B and SN75162B are characterized for operation from 0°C to 70°C.

### Function Tables

SN75161B RECEIVE/TRANSMIT

| CONTROLS           |    |                  | BUS-MANAGEMENT CHANNELS |     |     |     |     | DATA-TRANSFER CHANNELS |      |      |
|--------------------|----|------------------|-------------------------|-----|-----|-----|-----|------------------------|------|------|
| DC                 | TE | ATN <sup>†</sup> | ATN <sup>†</sup>        | SRQ | REN | IFC | EOI | DAV                    | NDAC | NRFD |
| (Controlled by DC) |    |                  |                         |     |     |     |     | (Controlled by TE)     |      |      |
| H                  | H  | H                | R                       | T   | R   | R   | T   | T                      | R    | R    |
| H                  | H  | L                |                         |     |     |     | R   |                        |      |      |
| L                  | L  | H                | T                       | R   | T   | T   | R   | R                      | T    | T    |
| L                  | L  | L                |                         |     |     |     | T   |                        |      |      |
| H                  | L  | X                | R                       | T   | R   | R   | R   | R                      | T    | T    |
| L                  | H  | X                | T                       | R   | T   | T   | T   | T                      | R    | R    |

H = high level, L = low level, R = receive, T = transmit, X = irrelevant

Direction of data transmission is from the terminal side to the bus side, and the direction of data receiving is from the bus side to the terminal side. Data transfer is noninverting in both directions.

<sup>†</sup> ATN is a normal transceiver channel that functions additionally as an internal direction control or talk enable for EOI whenever the DC and TE inputs are in the same state. When DC and TE are in opposite states, the ATN channel functions as an independent transceiver only.

SN75162B RECEIVE/TRANSMIT

| CONTROLS |    |    |      | BUS-MANAGEMENT CHANNELS |     |                    |     |     | DATA-TRANSFER CHANNELS |      |      |
|----------|----|----|------|-------------------------|-----|--------------------|-----|-----|------------------------|------|------|
| SC       | DC | TE | ATN† | ATN†                    | SRQ | REN                | IFC | EOI | DAV                    | NDAC | NRFD |
|          |    |    |      | (Controlled by DC)      |     | (Controlled by SC) |     |     | (Controlled by TE)     |      |      |
|          | H  | H  | H    | R                       | T   |                    |     | T   | T                      | R    | R    |
|          | H  | H  | L    |                         |     |                    |     | R   |                        |      |      |
|          | L  | L  | H    | T                       | R   |                    |     | R   | R                      | T    | T    |
|          | L  | L  | L    |                         |     |                    |     | T   |                        |      |      |
|          | H  | L  | X    | R                       | T   |                    |     | R   | R                      | T    | T    |
|          | L  | H  | X    | T                       | R   |                    |     | T   | T                      | R    | R    |
| H        |    |    |      |                         |     | T                  | T   |     |                        |      |      |
| L        |    |    |      |                         |     | R                  | R   |     |                        |      |      |

H = high level, L = low level, R = receive, T = transmit, X = irrelevant

Direction of data transmission is from the terminal side to the bus side, and the direction of data receiving is from the bus side to the terminal side. Data transfer is noninverting in both directions.

<sup>†</sup> ATN is a normal transceiver channel that functions additionally as an internal direction control or talk enable for EOI whenever the DC and TE inputs are in the same state. When DC and TE are in opposite states, the ATN channel functions as an independent transceiver only.



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# SN75161B, SN75162B

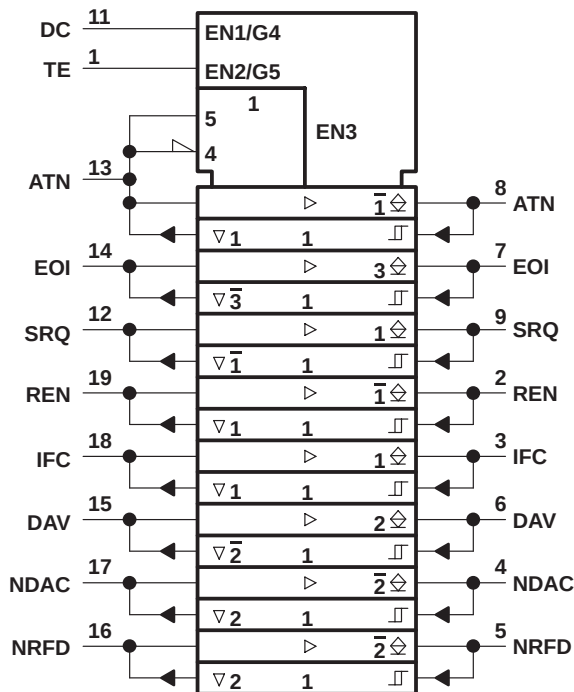
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CHANNEL-IDENTIFICATION TABLE

| NAME | IDENTITY                       | CLASS          |
|------|--------------------------------|----------------|
| DC   | Direction Control              | Control        |
| TE   | Talk Enable                    |                |
| SC   | System Control (SN75162B only) |                |
| ATN  | Attention                      |                |
| SRQ  | Service Request                |                |
| REN  | Remote Enable                  | Bus Management |
| IFC  | Interface Clear                |                |
| EOI  | End of Identity                |                |
| DAV  | Data Valid                     | Data Transfer  |
| NDAC | Not Data Accepted              |                |
| NRFD | Not Ready for Data             |                |

SN75161B logic symbol<sup>†</sup>

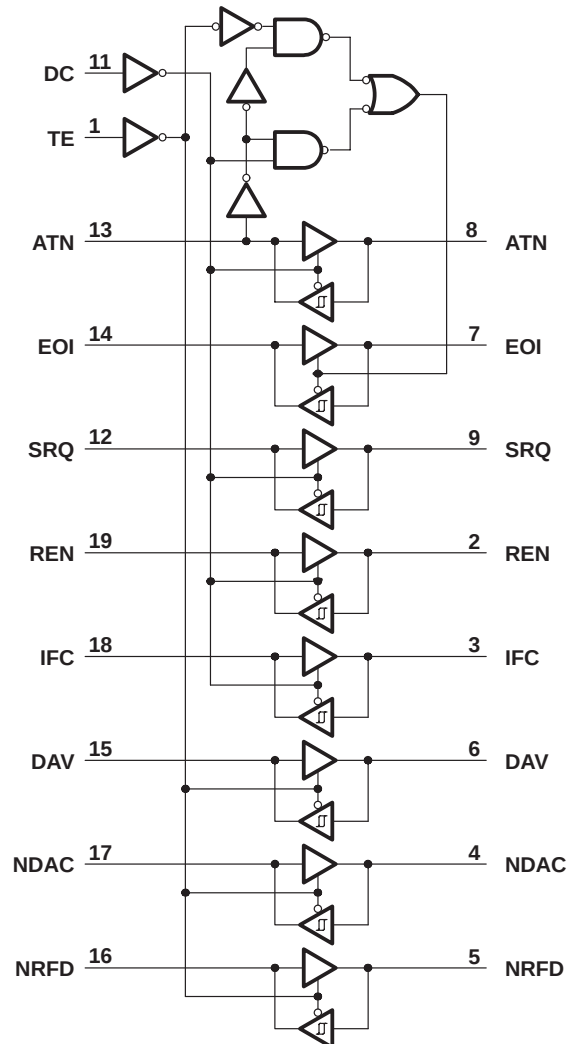


<sup>†</sup> This symbol is in accordance with IEEE Std 91-1984 and IEC Publication 617-12.

▽ Designates 3-state outputs

⊗ Designates passive-pullup outputs

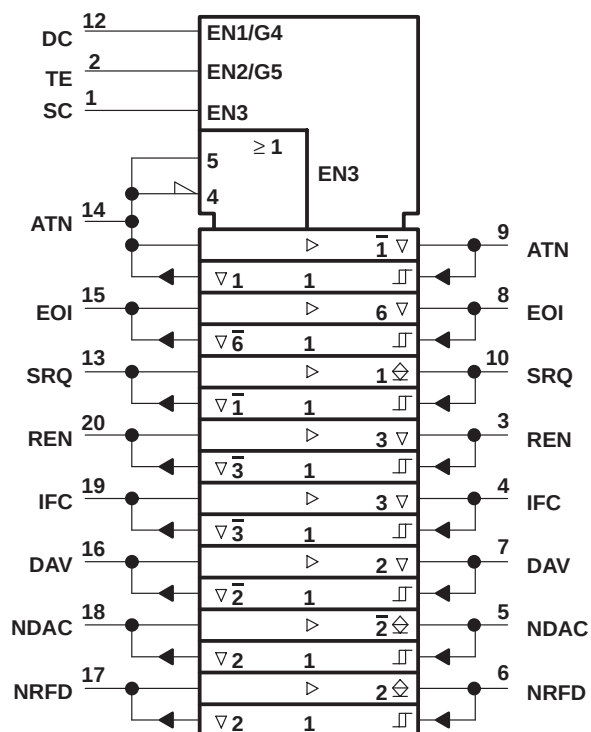
SN75161B logic diagram (positive logic)



# SN75161B, SN75162B OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

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SN75162B logic symbol†

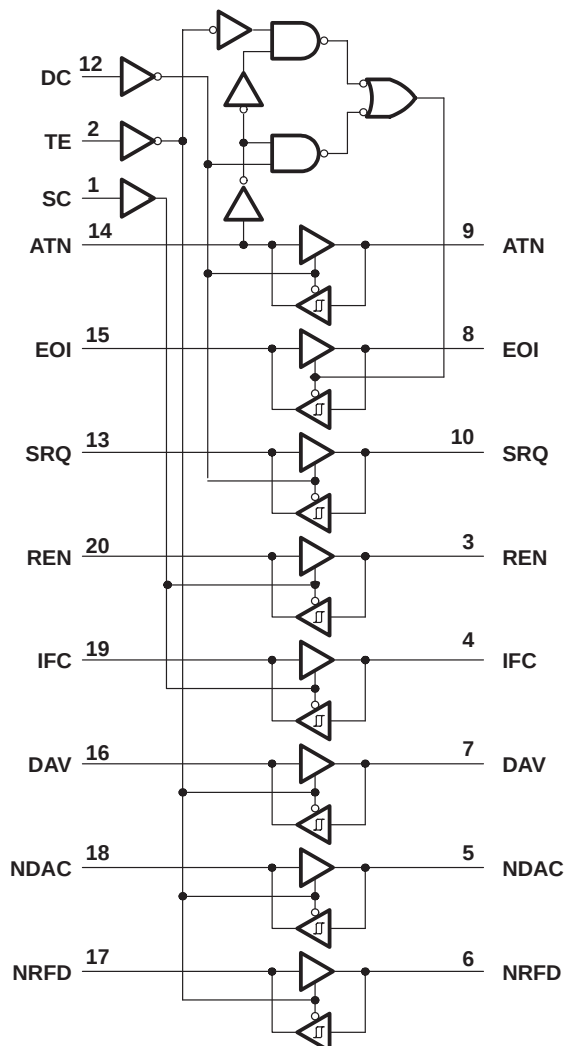


†This symbol is in accordance with IEEE Std 91-1984 and IEC Publication 617-12.

▽ Designates 3-state outputs

◇ Designates passive-pullup outputs

SN75162B logic diagram (positive logic)



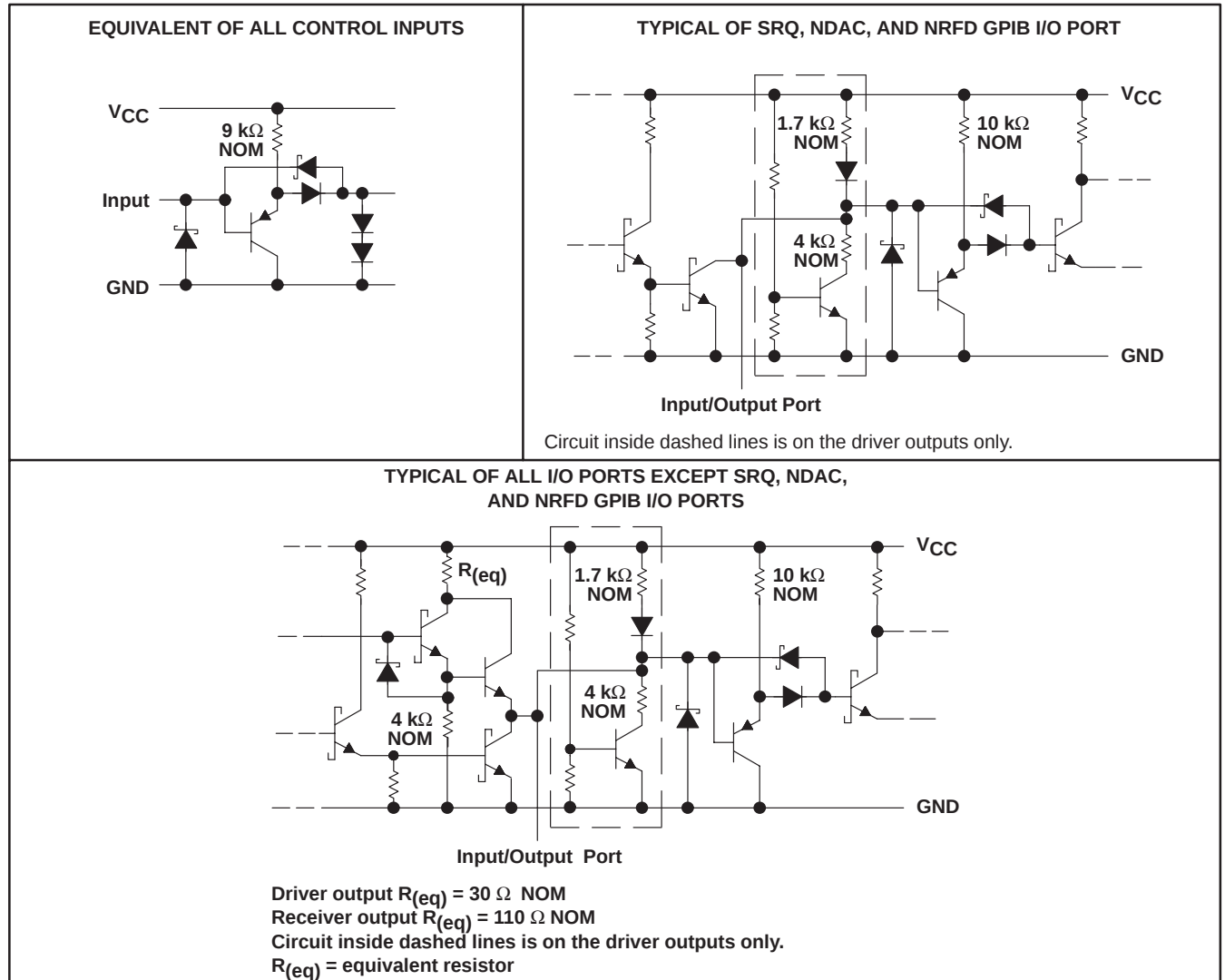
Pin numbers shown are for the N package.

# SN75161B, SN75162B

## OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

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### schematics of inputs and outputs



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                  |                              |
|------------------------------------------------------------------|------------------------------|
| Supply voltage, $V_{CC}$ (see Note 1)                            | 7 V                          |
| Input voltage, $V_I$                                             | 5.5 V                        |
| Low-level driver output current, $I_{OL}$                        | 100 mA                       |
| Continuous total power dissipation                               | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$                      | 0°C to 70°C                  |
| Storage temperature range, $T_{stg}$                             | –65°C to 150°C               |
| Lead temperature 1,6 mm (1/16) inch from the case for 10 seconds | 260°C                        |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network ground terminal.

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## OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

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DISSIPATION RATING TABLE

| PACKAGE     | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | DERATING FACTOR<br>ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 70^\circ\text{C}$<br>POWER RATING |
|-------------|---------------------------------------------|---------------------------------------------------|------------------------------------------|
| DW (20 pin) | 1125 mW                                     | 9.0 mW/ $^\circ\text{C}$                          | 720 mW                                   |
| DW (24 pin) | 1350 mW                                     | 10.8 mW/ $^\circ\text{C}$                         | 864 mW                                   |
| N (20 pin)  | 1150 mW                                     | 9.2 mW/ $^\circ\text{C}$                          | 736 mW                                   |
| N (22 pin)  | 1700 mW                                     | 13.6 mW/ $^\circ\text{C}$                         | 1088 mW                                  |

### recommended operating conditions

|                                       |                                | MIN  | NOM | MAX  | UNIT             |
|---------------------------------------|--------------------------------|------|-----|------|------------------|
| Supply voltage, $V_{CC}$              |                                | 4.75 | 5   | 5.25 | V                |
| High-level input voltage, $V_{IH}$    |                                | 2    |     |      | V                |
| Low-level input voltage, $V_{IL}$     |                                |      |     | 0.8  | V                |
| High-level output current, $I_{OH}$   | Bus ports with 3-state outputs |      |     | -5.2 | mA               |
|                                       | Terminal ports                 |      |     | -800 | $\mu\text{A}$    |
| Low-level output current, $I_{OL}$    | Bus ports                      |      |     | 48   | mA               |
|                                       | Terminal ports                 |      |     | 16   |                  |
| Operating free-air temperature, $T_A$ |                                | 0    |     | 70   | $^\circ\text{C}$ |



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## OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

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**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

| PARAMETER                                   |                                            |                             | TEST CONDITIONS                                                                      | MIN  | TYP <sup>†</sup> | MAX  | UNIT          |
|---------------------------------------------|--------------------------------------------|-----------------------------|--------------------------------------------------------------------------------------|------|------------------|------|---------------|
| $V_{IK}$                                    | Input clamp voltage                        |                             | $I_I = -18 \text{ mA}$                                                               | -0.8 | -1.5             |      | V             |
| $V_{hys}$                                   | Hysteresis voltage ( $V_{IT+} - V_{IT-}$ ) | Bus                         | See Figure 7                                                                         | 0.4  | 0.65             |      | V             |
| $V_{OH}^{\ddagger}$                         | High-level output voltage                  | Terminal                    | $I_{OH} = -800 \mu\text{A}$                                                          | 2.7  | 3.5              |      | V             |
|                                             |                                            | Bus                         | $I_{OH} = -5.2 \text{ mA}$                                                           | 2.5  | 3.3              |      |               |
| $V_{OL}$                                    | Low-level output voltage                   | Terminal                    | $I_{OL} = 16 \text{ mA}$                                                             |      | 0.3              | 0.5  | V             |
|                                             |                                            | Bus                         | $I_{OL} = 48 \text{ mA}$                                                             |      | 0.35             | 0.5  |               |
| $I_I$                                       | Input current at maximum input voltage     | Terminal                    | $V_I = 5.5 \text{ V}$                                                                |      | 0.2              | 100  | $\mu\text{A}$ |
| $I_{IH}$                                    | High-level input current                   | Terminal and control inputs | $V_I = 2.7 \text{ V}$                                                                |      | 0.1              | 20   | $\mu\text{A}$ |
| $I_{IL}$                                    | Low-level input current                    |                             | $V_I = 0.5 \text{ V}$                                                                |      | -10              | -100 | $\mu\text{A}$ |
| $V_{I/O(\text{bus})}$ Voltage at bus port   |                                            | Driver disabled             | $I_{I(\text{bus})} = 0$                                                              | 2.5  | 3.0              | 3.7  | V             |
|                                             |                                            |                             | $I_{I(\text{bus})} = -12 \text{ mA}$                                                 |      |                  | -1.5 |               |
| $I_{I/O(\text{bus})}$ Current into bus port | Power on                                   | Driver disabled             | $V_{I(\text{bus})} = -1.5 \text{ V to } 0.4 \text{ V}$                               | -1.3 |                  |      | mA            |
|                                             |                                            |                             | $V_{I(\text{bus})} = 0.4 \text{ V to } 2.5 \text{ V}$                                | 0    |                  | -3.2 |               |
|                                             |                                            |                             | $V_{I(\text{bus})} = 2.5 \text{ V to } 3.7 \text{ V}$                                |      |                  | 2.5  |               |
|                                             |                                            |                             | $V_{I(\text{bus})} = 3.7 \text{ V to } 5 \text{ V}$                                  | 0    |                  | 2.5  |               |
|                                             |                                            |                             | $V_{I(\text{bus})} = 5 \text{ V to } 5.5 \text{ V}$                                  | 0.7  |                  | 2.5  |               |
|                                             | Power off                                  |                             | $V_{CC} = 0, V_{I(\text{bus})} = 0 \text{ V to } 2.5 \text{ V}$                      |      |                  | -40  | $\mu\text{A}$ |
| $I_{OS}$                                    | Short-circuit output current               | Terminal                    |                                                                                      | -15  | -35              | -75  | mA            |
|                                             |                                            | Bus                         |                                                                                      | -25  | -50              | -125 |               |
| $I_{CC}$                                    | Supply current                             |                             | No load, TE, DE, and SC low                                                          |      |                  | 110  | mA            |
| $C_{I/O(\text{bus})}$                       | Bus-port capacitance                       |                             | $V_{CC} = 5 \text{ V to } 0, V_{I/O} = 0 \text{ to } 2 \text{ V}, f = 1 \text{ MHz}$ |      | 16               |      | pF            |

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

<sup>‡</sup>  $V_{OH}$  applies for 3-state outputs only.

# SN75161B, SN75162B

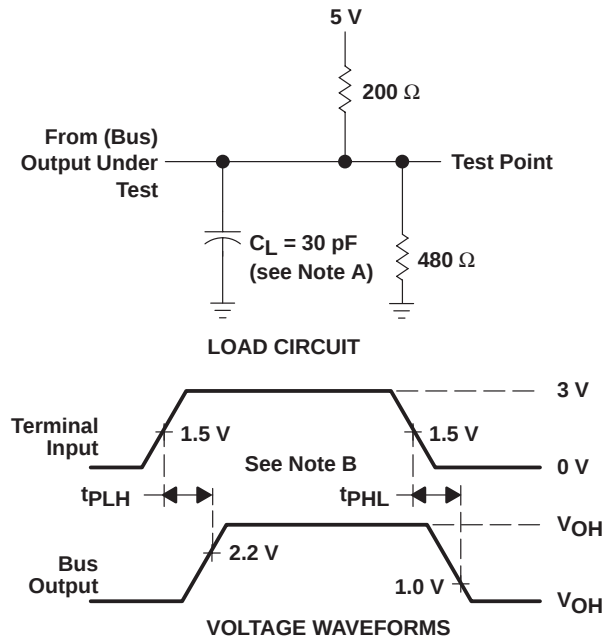
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switching characteristics,  $V_{CC} = 5\text{ V}$ ,  $C_L = 15\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

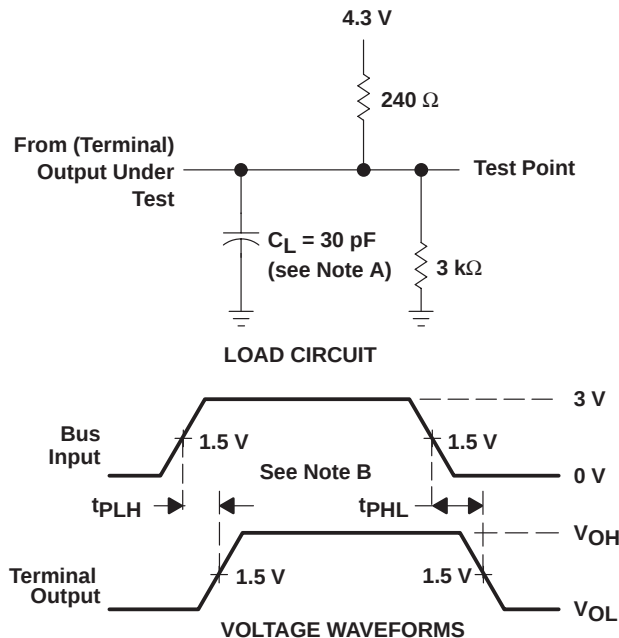
| PARAMETER                                                      | FROM<br>(INPUT)    | TO<br>(OUTPUT)                             | TEST<br>CONDITIONS                     | MIN | TYP | MAX | UNIT |
|----------------------------------------------------------------|--------------------|--------------------------------------------|----------------------------------------|-----|-----|-----|------|
| $t_{PLH}$ Propagation delay time,<br>low- to high-level output | Terminal           | Bus                                        | $C_L = 30\text{ pF}$ ,<br>See Figure 1 |     | 14  | 20  | ns   |
| $t_{PHL}$ Propagation delay time,<br>high- to low-level output |                    |                                            |                                        |     | 14  | 20  |      |
| $t_{PLH}$ Propagation delay time,<br>low- to high-level output | Terminal           | Bus<br>(SRQ, NDAC,<br>NRFD)                | $C_L = 30\text{ pF}$ ,<br>See Figure 1 |     | 29  | 35  | ns   |
| $t_{PLH}$ Propagation delay time,<br>low- to high-level output | Bus                | Terminal                                   | $C_L = 30\text{ pF}$ ,<br>See Figure 2 |     | 10  | 20  | ns   |
| $t_{PHL}$ Propagation delay time,<br>high- to low-level output |                    |                                            |                                        |     | 15  | 22  |      |
| $t_{PZH}$ Output enable time to high level                     | TE,DC,<br>or<br>SC | Bus (ATN,<br>EOI, REN,<br>IFC, and<br>DAV) | See Figure 3                           |     |     | 60  | ns   |
| $t_{PHZ}$ Output disable time from high level                  |                    |                                            |                                        |     |     | 45  |      |
| $t_{PZL}$ Output enable time to low level                      |                    |                                            |                                        |     |     | 60  |      |
| $t_{PLZ}$ Output disable time from low level                   |                    |                                            |                                        |     |     | 55  |      |
| $t_{PZH}$ Output enable time to high level                     | TE,DC,<br>or<br>SC | Terminal                                   | See Figure 4                           |     |     | 55  | ns   |
| $t_{PHZ}$ Output disable time from high level                  |                    |                                            |                                        |     |     | 50  |      |
| $t_{PZL}$ Output enable time to low level                      |                    |                                            |                                        |     |     | 45  |      |
| $t_{PLZ}$ Output disable time from low level                   |                    |                                            |                                        |     |     | 55  |      |

## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The input pulse is supplied by a generator having the following characteristics:  $PRR \leq 1$  MHz, 50% duty cycle,  $t_r \leq 6$  ns,  $t_f \leq 6$  ns,  $Z_O = 50 \Omega$ .

**Figure 1. Terminal-to-Bus Load Circuit and Voltage Waveforms**



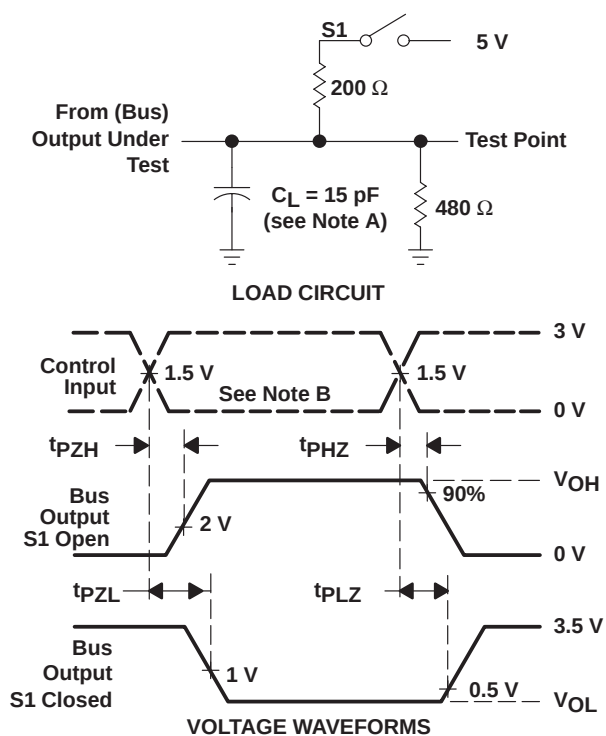
- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The input pulse is supplied by a generator having the following characteristics:  $PRR \leq 1$  MHz, 50% duty cycle,  $t_r \leq 6$  ns,  $t_f \leq 6$  ns,  $Z_O = 50 \Omega$ .

**Figure 2. Bus-to-Terminal Load Circuit and Voltage Waveforms**

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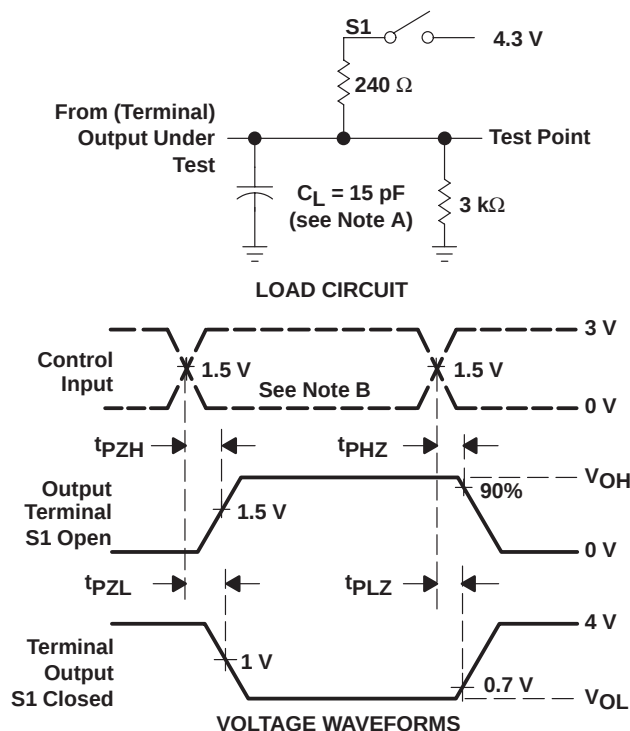
## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The input pulse is supplied by a generator having the following characteristics:  $\text{PRR} \leq 1 \text{ MHz}$ , 50% duty cycle,  $t_r \leq 6 \text{ ns}$ ,  $t_f \leq 6 \text{ ns}$ ,  $Z_O = 50 \Omega$ .

**Figure 3. Bus Enable and Disable Times Load Circuit and Voltage Waveforms**

## PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.  
B. The Input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t<sub>r</sub> ≤ 6 ns, t<sub>f</sub> ≤ 6 ns, Z<sub>O</sub> = 50 Ω.

**Figure 4. Terminal Enable and Disable Times Load Circuit and Voltage Waveforms**

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OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

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TYPICAL CHARACTERISTICS

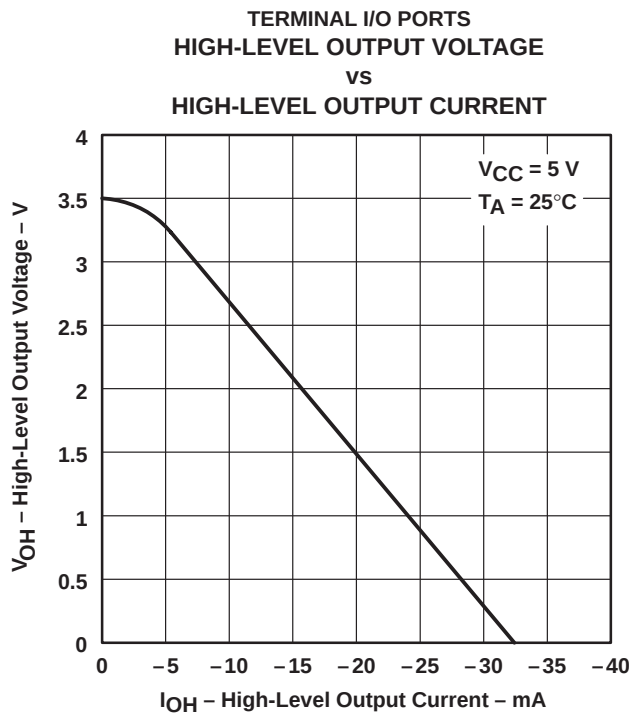


Figure 5

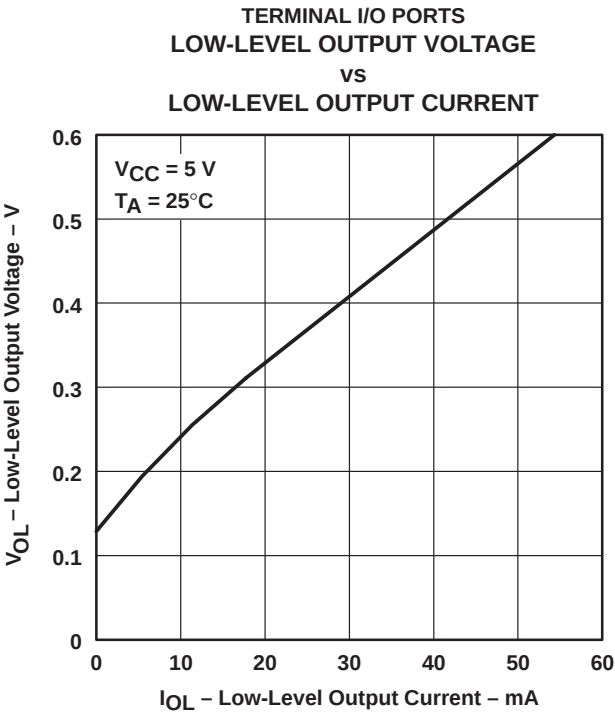


Figure 6

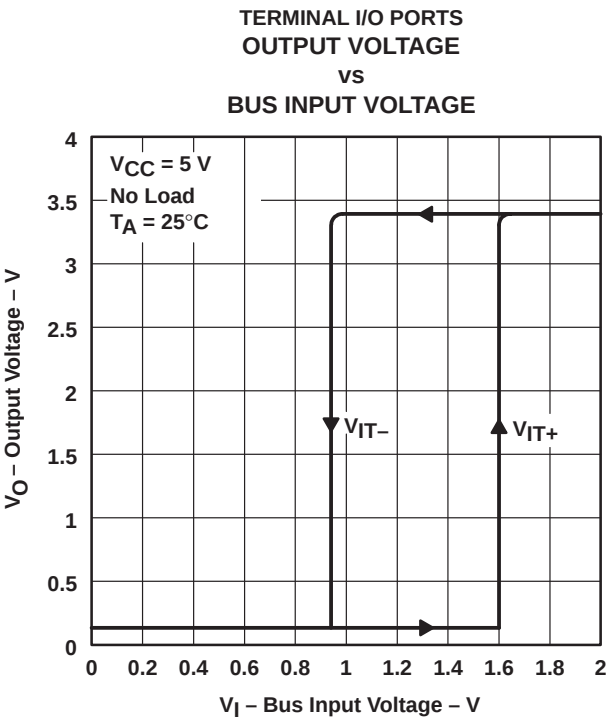


Figure 7

# SN75161B, SN75162B OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

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## TYPICAL CHARACTERISTICS

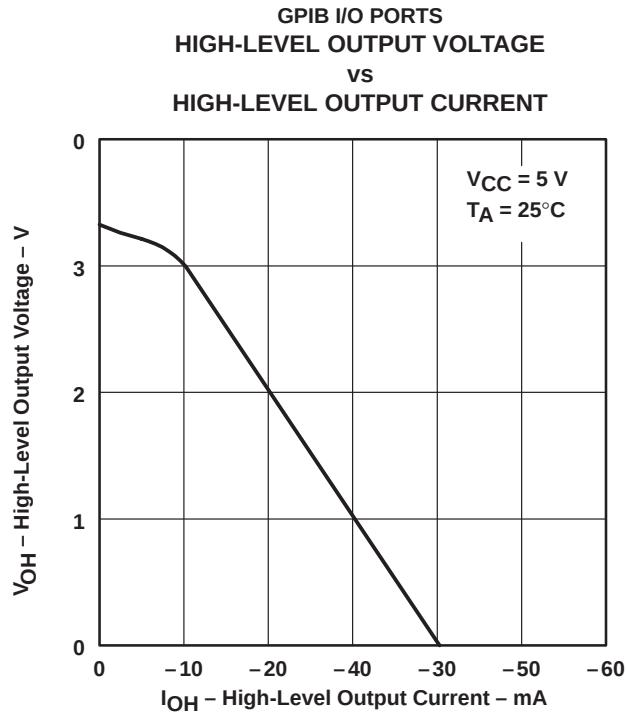


Figure 8

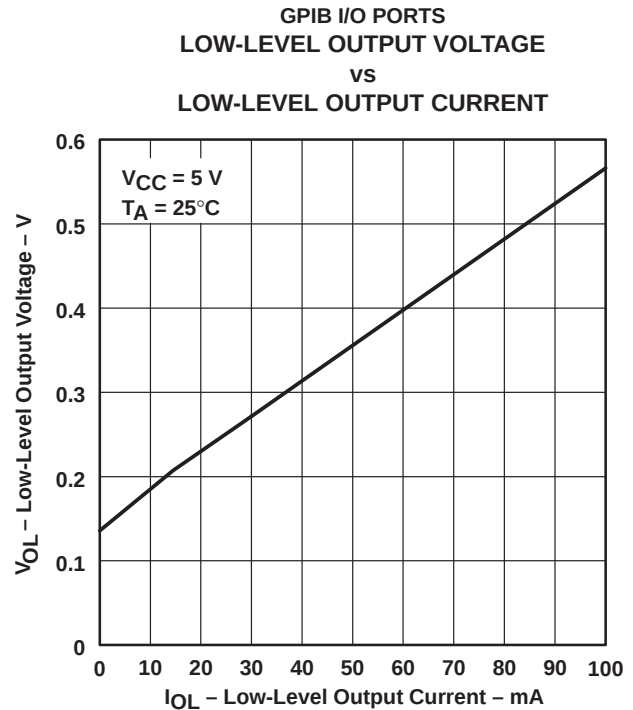


Figure 9

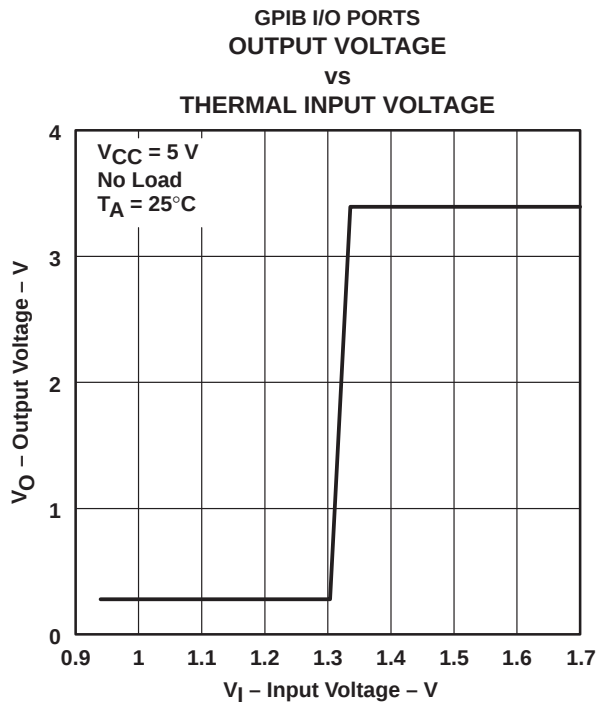


Figure 10

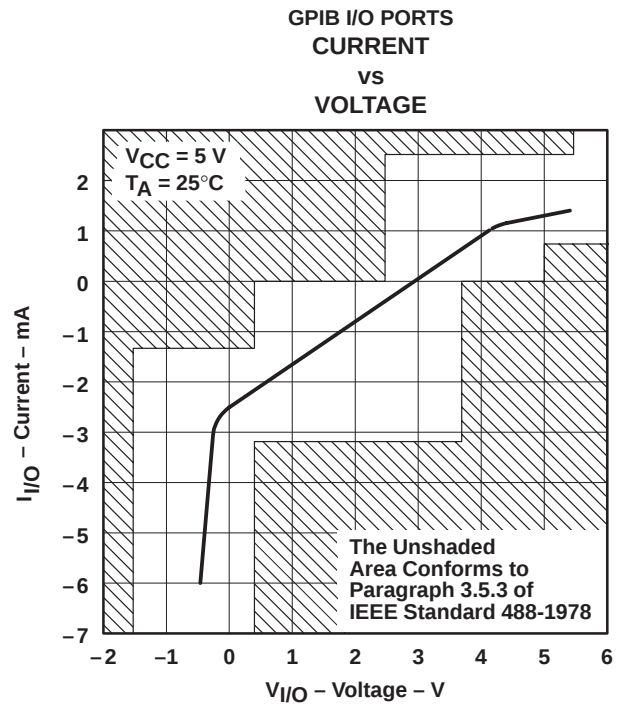


Figure 11

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN75161BDW       | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75161BDWG4     | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75161BDWR      | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75161BDWRE4    | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75161BDWRG4    | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75161BN        | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75161BNE4      | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75162BDW       | ACTIVE                | SOIC         | DW              | 24   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75162BDWE4     | ACTIVE                | SOIC         | DW              | 24   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75162BDWG4     | ACTIVE                | SOIC         | DW              | 24   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75162BDWR      | ACTIVE                | SOIC         | DW              | 24   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75162BDWRE4    | ACTIVE                | SOIC         | DW              | 24   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75162BDWRG4    | ACTIVE                | SOIC         | DW              | 24   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75162BN        | OBSOLETE              | PDIP         | N               | 22   |             | TBD                     | Call TI          | Call TI                      |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN75161BDWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| SN75161BDWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| SN75162BDWR | SOIC         | DW              | 24   | 2000 | 330.0              | 24.4               | 10.75   | 15.7    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



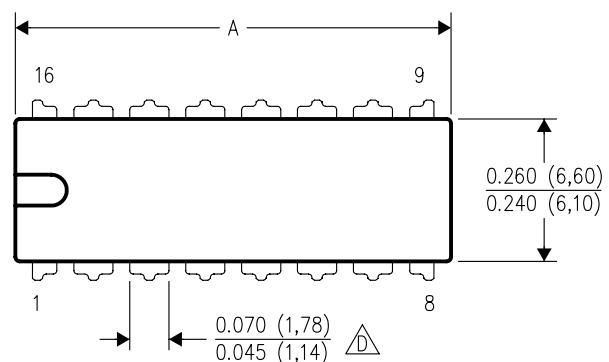
\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN75161BDWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN75161BDWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN75162BDWR | SOIC         | DW              | 24   | 2000 | 367.0       | 367.0      | 45.0        |

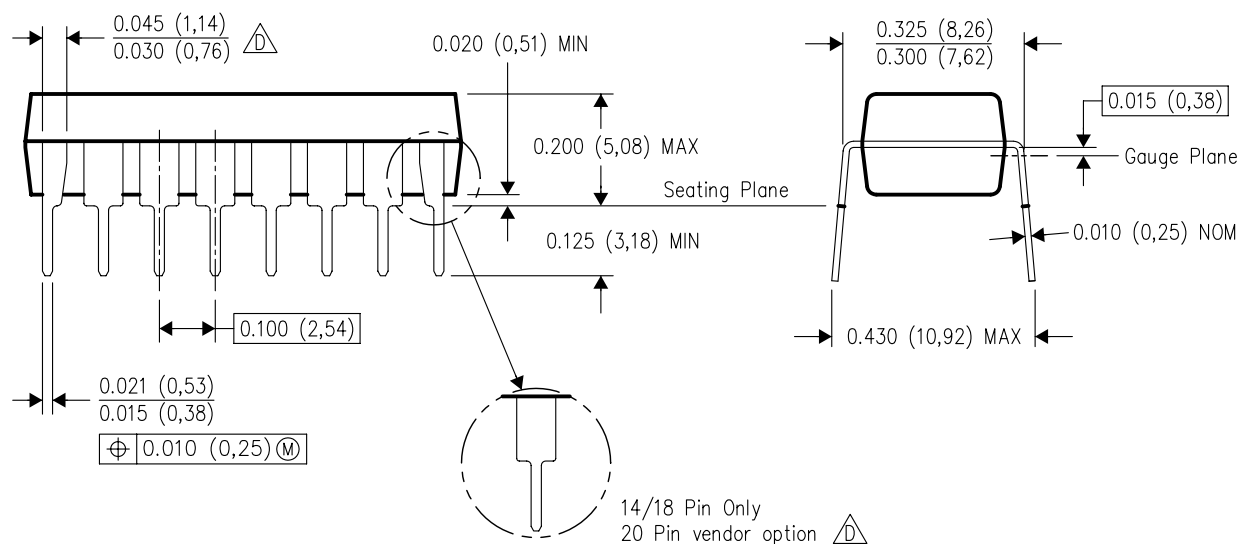
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |

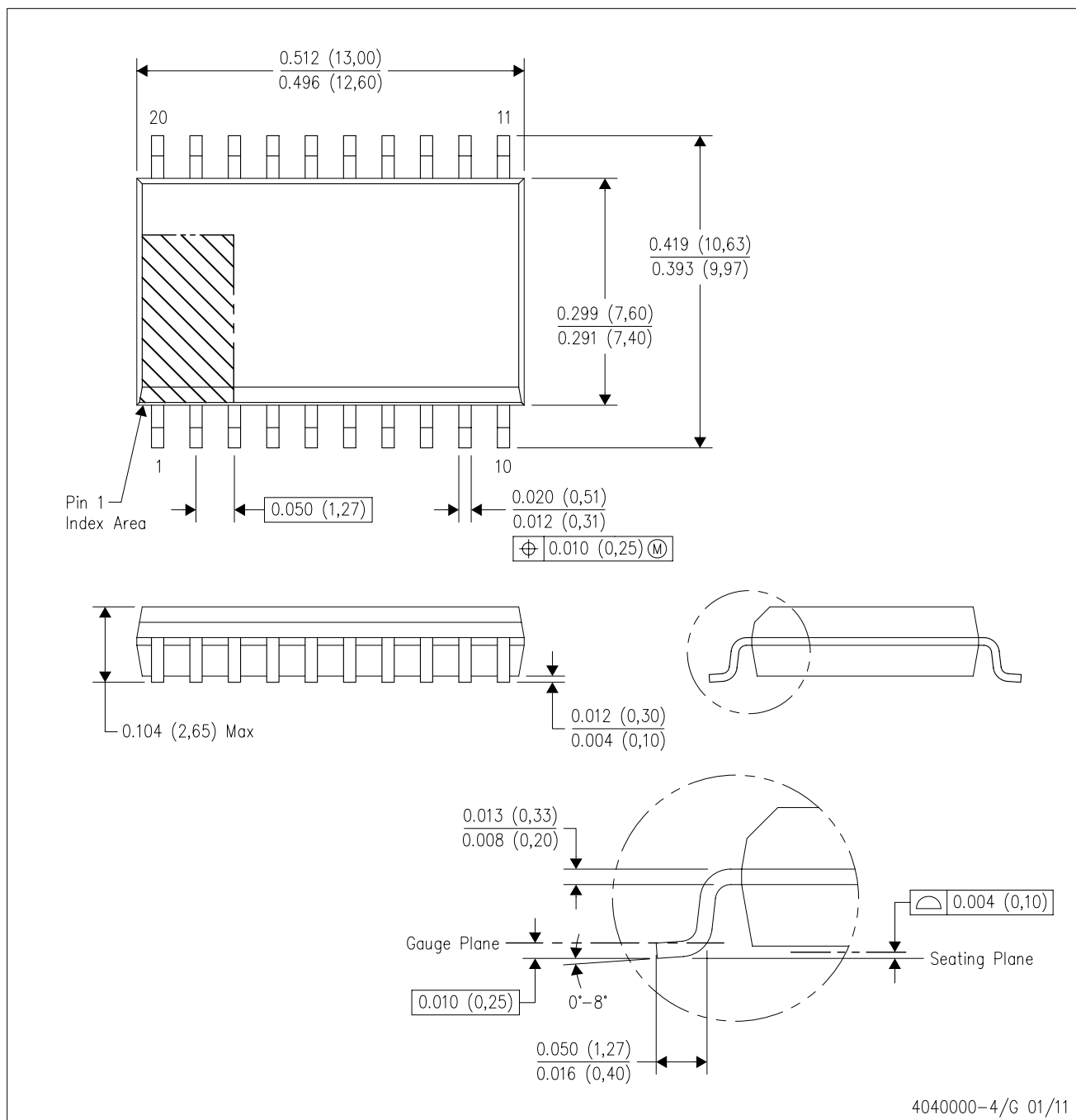


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)

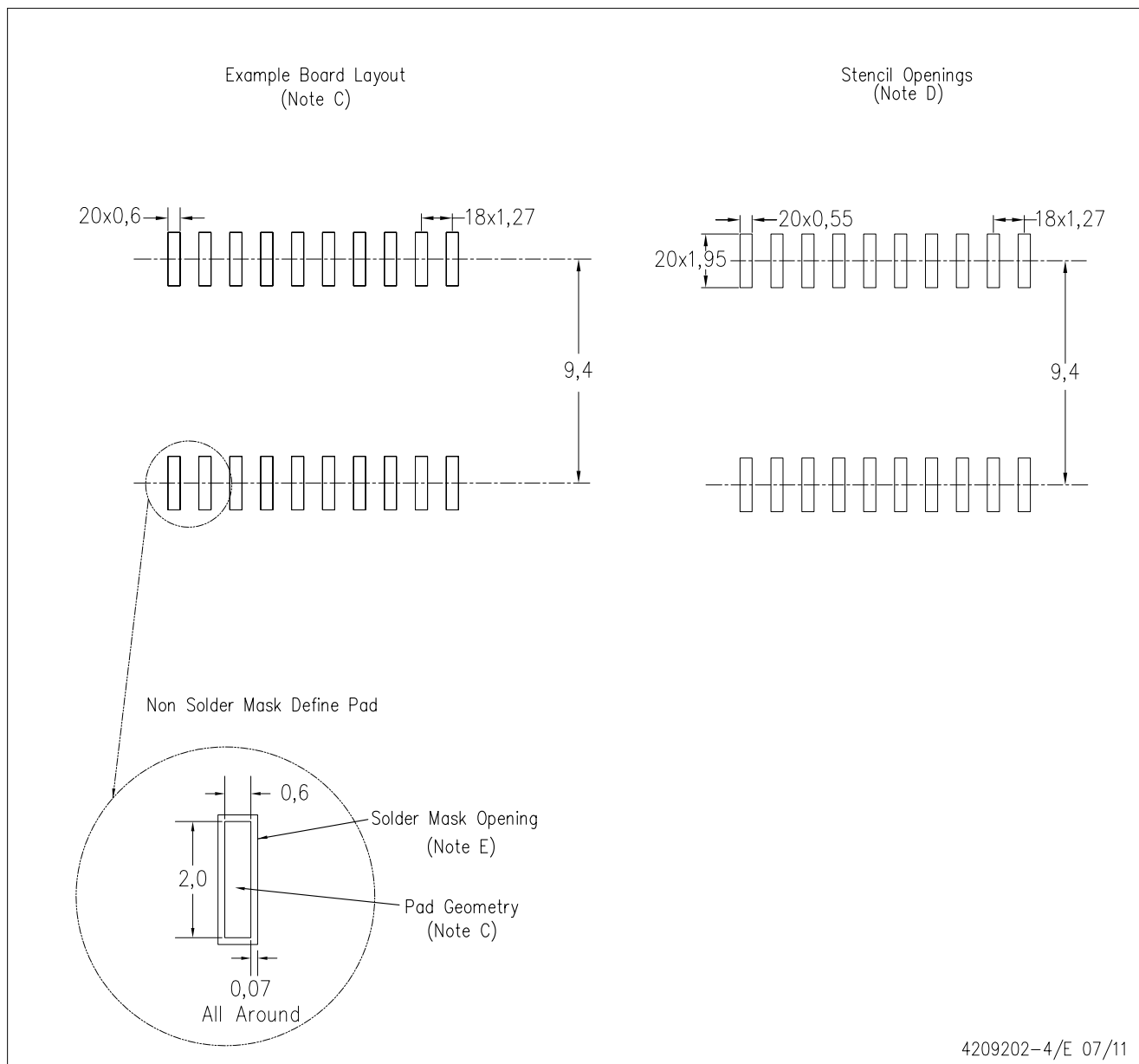
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

DW (R-PDSO-G20)

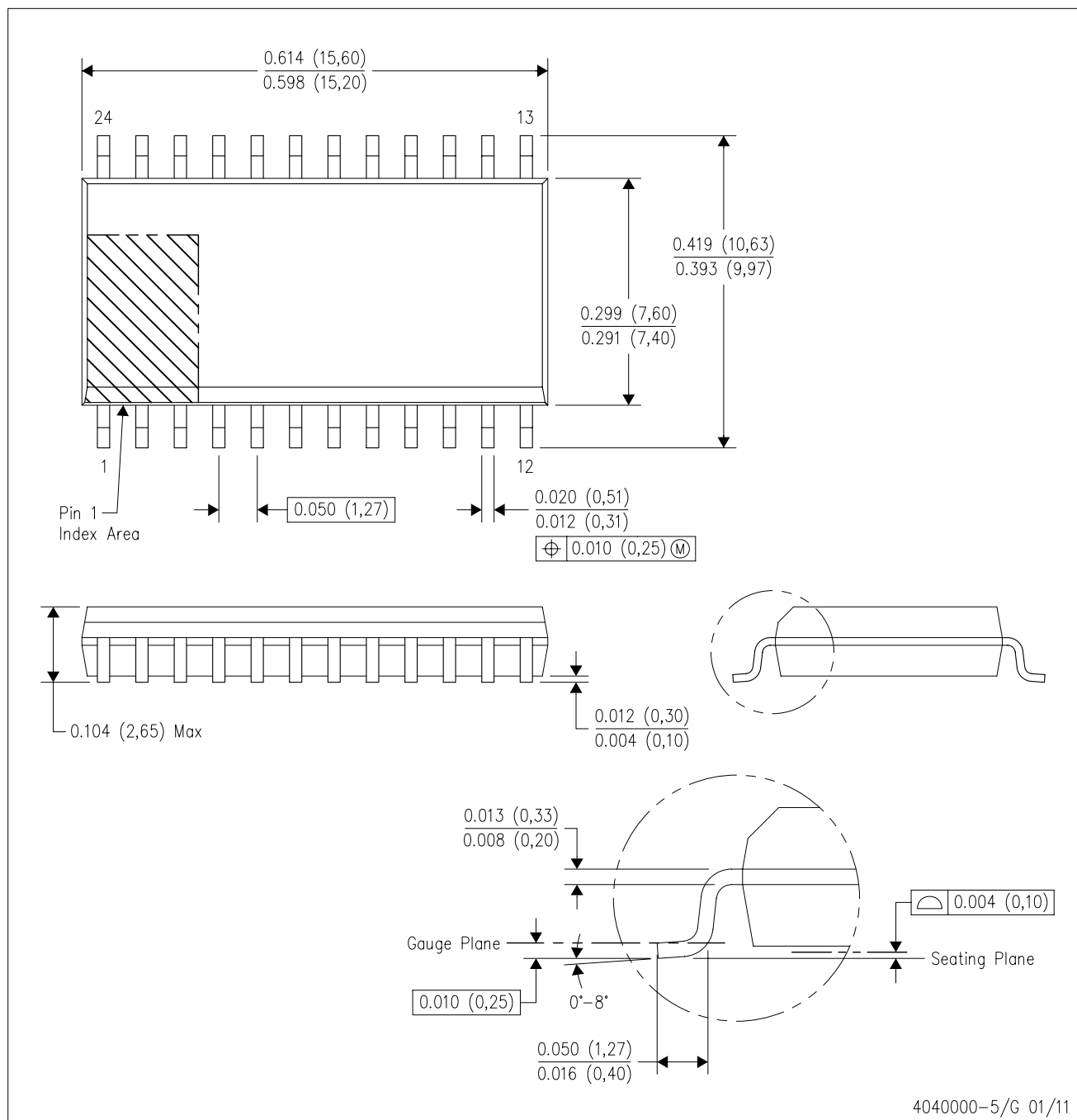
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AD.

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